

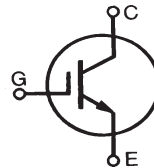
GenX3™ 300V IGBT

IXGK400N30A3

IXGX400N30A3*

*Obsolete Part Number

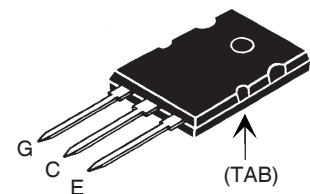
Ultra-low V_{sat} PT IGBTs for up to 10kHz switching



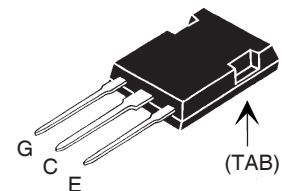
V_{CES} = 300V
I_{C25} = 400A
V_{CE(sat)} ≤ 1.15V

Symbol	Test Conditions	Maximum Ratings	
V _{CES}	T _J = 25°C to 150°C	300	V
V _{CGR}	T _J = 25°C to 150°C, R _{GE} = 1MΩ	300	V
V _{GES}	Continuous	±20	V
V _{GEM}	Transient	±30	V
I _{C25}	T _C = 25°C	400	A
I _{C110}	T _C = 110°C	200	A
I _{LRMS}	Terminal Current Limit	75	A
I _{CM}	T _C = 25°C, 1ms	400	A
SSOA (RBSOA)	V _{GE} = 15V, T _{VJ} = 125°C, R _G = 1Ω Clamped inductive load	I _{CM} = 400 @ 0.8 • V _{CES}	A
P _C	T _C = 25°C	1000	W
T _J		-55 ... +150	°C
T _{JM}		150	°C
T _{stg}		-55 ... +150	°C
T _L	Maximum lead temperature for soldering	300	°C
T _{SOLD}	1.6 mm (0.062 in.) from case for 10	260	°C
M _d	Mounting torque (IXGK)	1.13/10	Nm/lb.in.
F _C	Mounting force (IXGX)	20..120/4.5..27	N/lb.
Weight	TO-264	10	g
	PLUS247	6	g

TO-264



PLUS247™



G = Gate E = Emitter
 C = Collector TAB = Collector

Features

- Optimized for low switching losses
- Square RBSOA
- High avalanche capability
- International standard packages

Advantages

- High power density
- Low gate drive requirement

Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- Inrush Current Protection Circuits

Symbol	Test Conditions (T _J = 25°C, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{CES}	I _C = 1mA, V _{GE} = 0V	300		V
V _{GE(th)}	I _C = 4mA, V _{CE} = V _{GE}	3.0		5.0 V
I _{CES}	V _{CE} = V _{CES} V _{GE} = 0V T _J = 125°C			50 μA 2 mA
I _{GES}	V _{CE} = 0V, V _{GE} = ±20V			±400 nA
V _{CE(sat)}	I _C = 100A, V _{GE} = 15V, Note 1 I _C = 400A	1.70	1.15	V V

Fig. 1. Output Characteristics @ 25°C

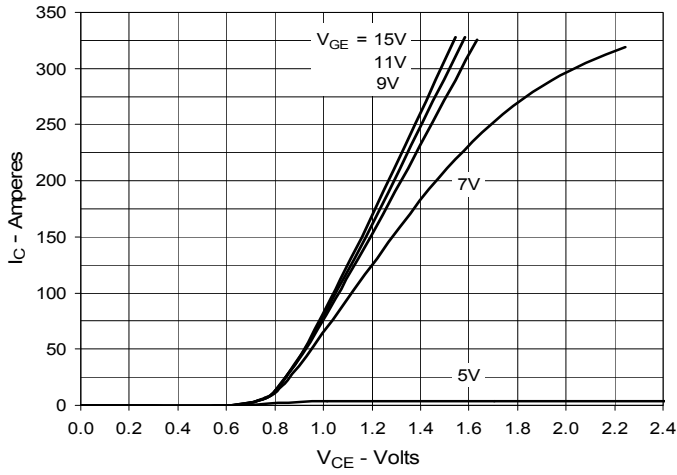


Fig. 2. Output Characteristics @ 125°C

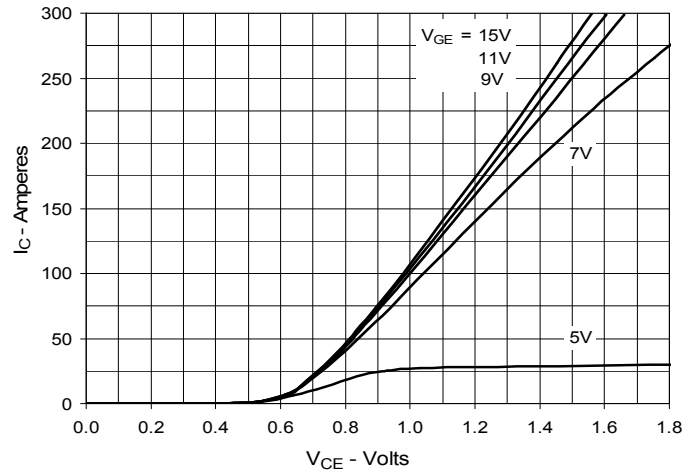


Fig. 3. Dependence of $V_{CE(sat)}$ on Junction Temperature

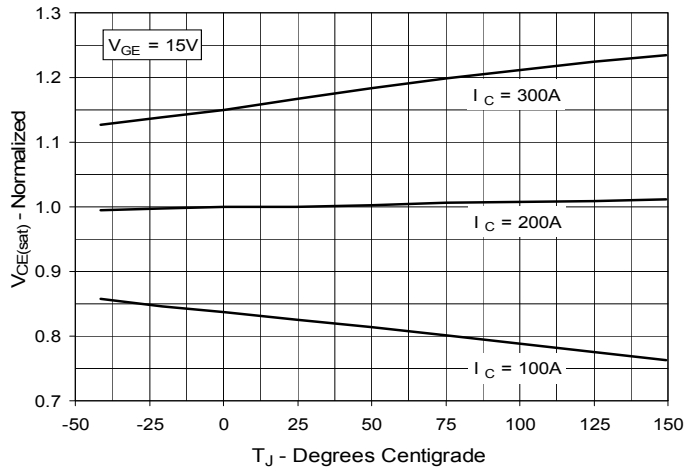


Fig. 4. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

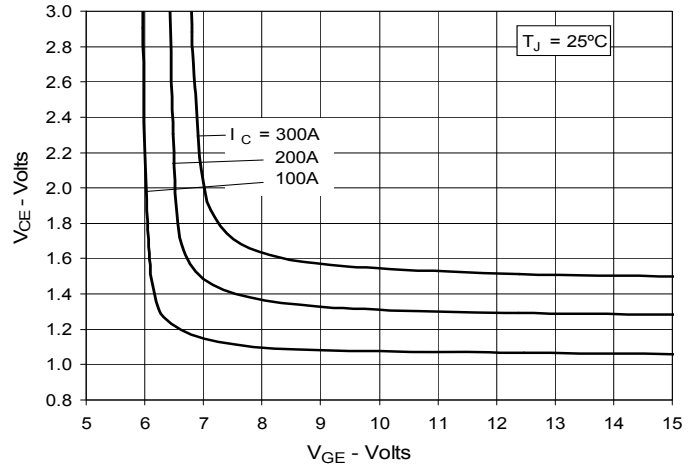


Fig. 5. Input Admittance

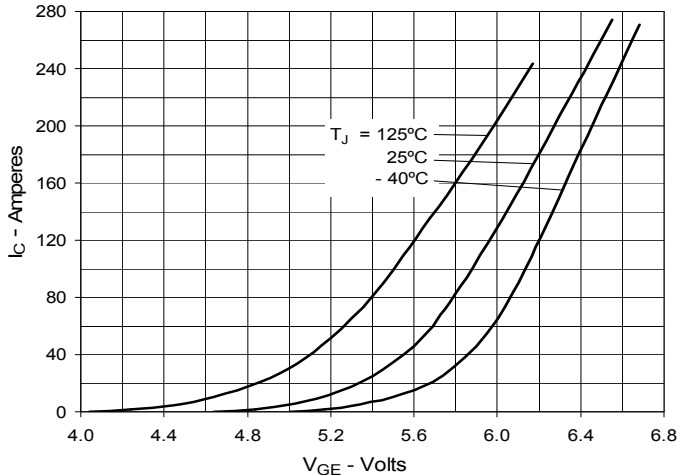


Fig. 6. Transconductance

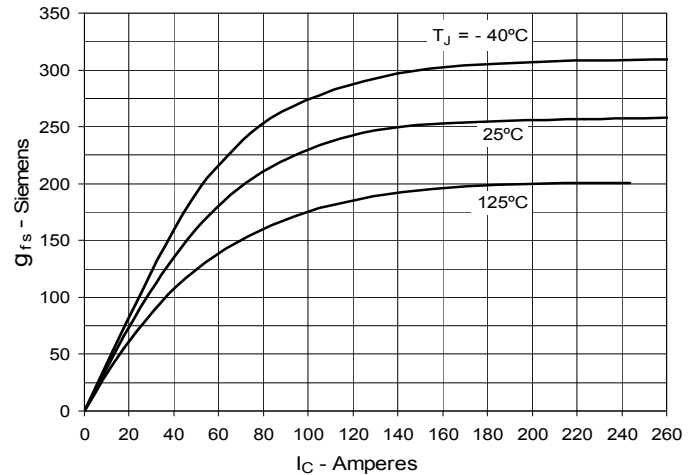


Fig. 7. Gate Charge

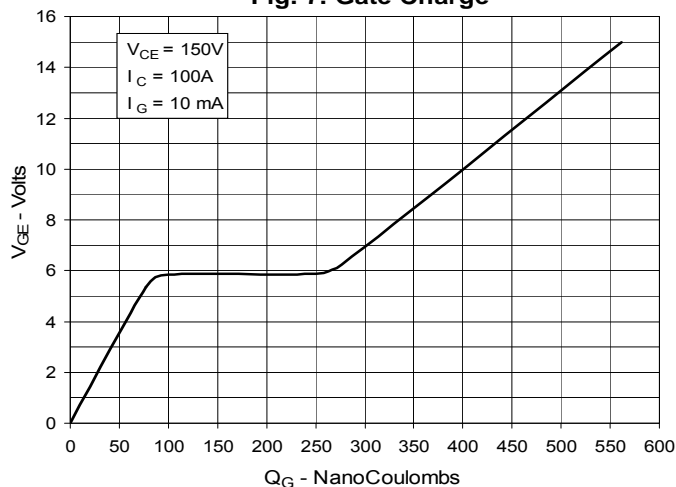


Fig. 8. Capacitance

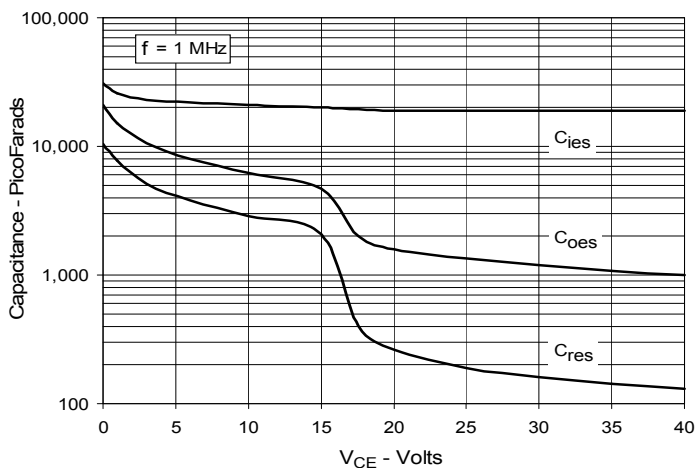


Fig. 9. Reverse-Bias Safe Operating Area

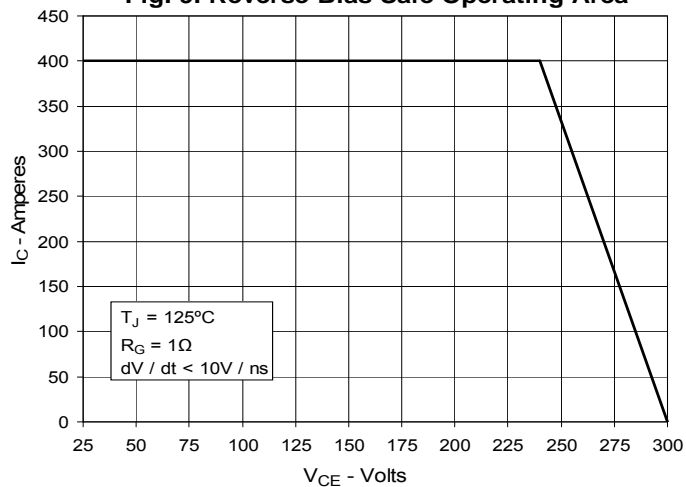


Fig. 10. Maximum Transient Thermal Impedance

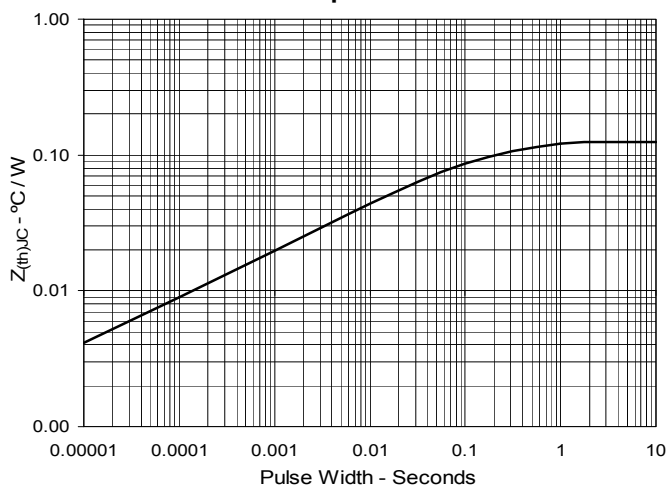


Fig. 11. Resistive Turn-on Rise Time vs. Junction Temperature

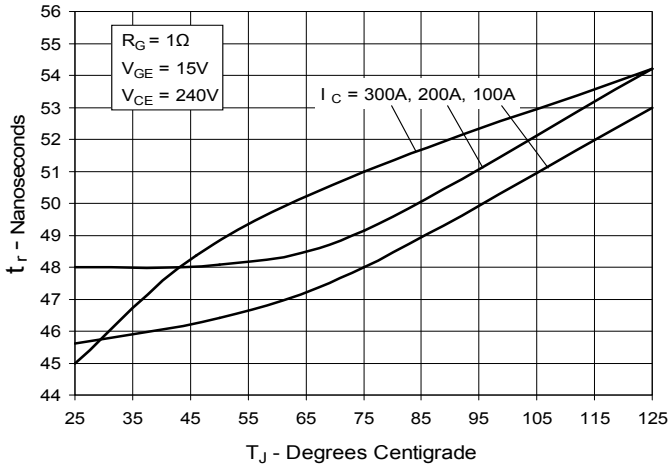


Fig. 12. Resistive Turn-on Rise Time vs. Collector Current

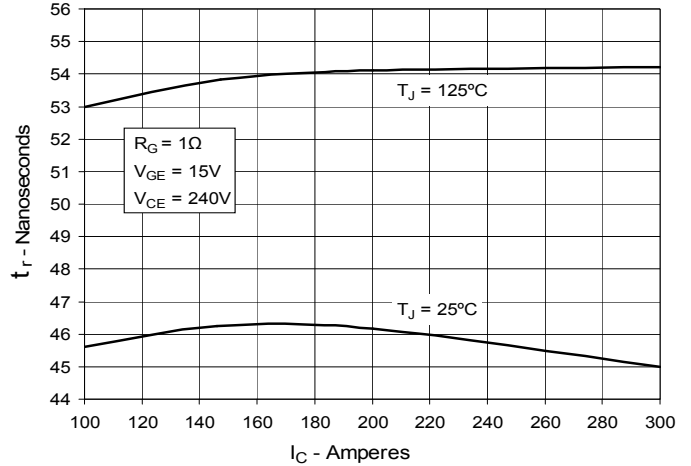


Fig. 13. Resistive Turn-on Switching Times vs. Gate Resistance

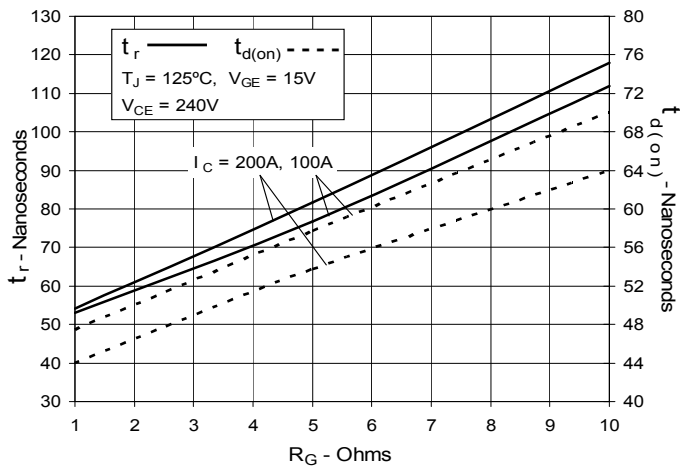


Fig. 14. Resistive Turn-off Switching Times vs. Junction Temperature

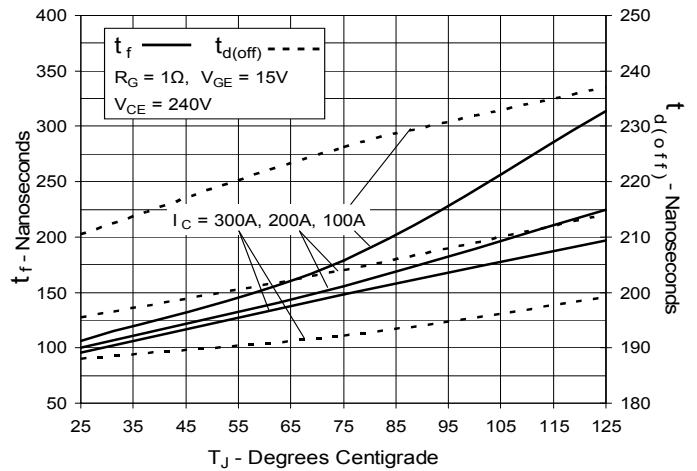


Fig. 15. Resistive Turn-off Switching Times vs. Gate Resistance

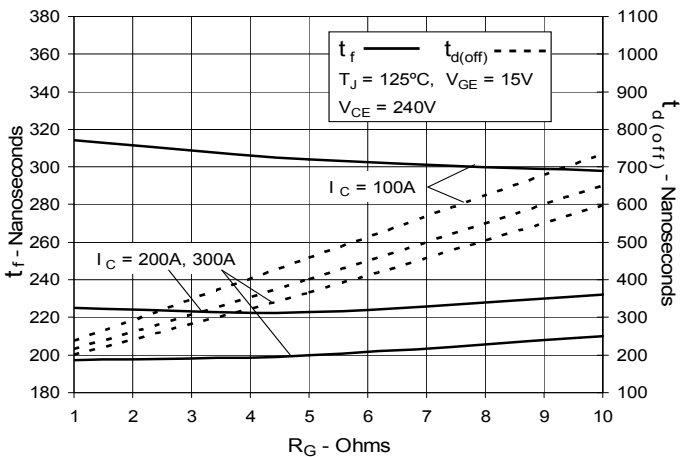
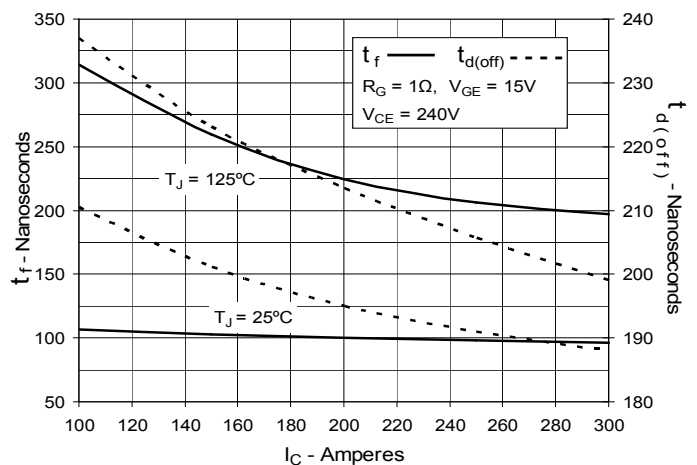


Fig. 16. Resistive Turn-off Switching Times vs. Collector Current





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